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# 2SB1002

# Silicon PNP Epitaxial



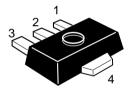
ADE-208-1035 (Z) 1st. Edition Mar. 2001

### **Application**

- Low frequency power amplifier
- Complementary pair with 2SD1368

### **Outline**

**UPAK** 



- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector (Flange)

# 2SB1002

## **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	Ratings	Unit	
Collector to base voltage	$V_{\text{CBO}}$	-70	V	
Collector to emitter voltage	$V_{\text{CEO}}$	<b>-</b> 50	V	
Emitter to base voltage	$V_{EBO}$	-6	V	
Collector current	I <sub>c</sub>	<b>-1</b>	А	
Collector peak current	i <sub>C(peak)</sub> *1	-1.5	Α	
Collector power dissipation	P <sub>C</sub> *2	1	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW ≤ 10 ms, Duty cycle ≤ 20%

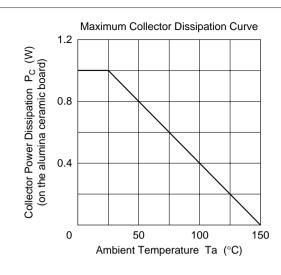
2. Value on the alumina ceramic board (12.5  $\times$  20  $\times$  0.7 mm)

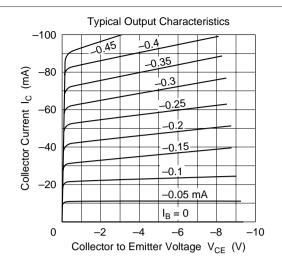
### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

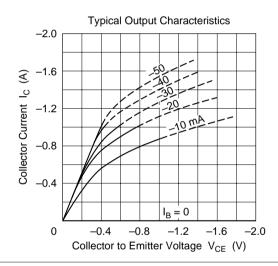
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-70	_	_	V	$I_{c} = -10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-50	_	_	V	$I_{C} = -1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-6	_	_	V	$I_{E} = -10 \mu A, I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	-0.1	μΑ	$V_{CB} = -50 \text{ V}, I_{E} = 0$
Emitter cutoff current	I <sub>EBO</sub>	_	_	-0.1	μΑ	$V_{EB} = -4 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	100	_	320		$V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-0.6	V	$I_{c} = -1 \text{ A},$ $I_{B} = -0.1 \text{ A (Pulse test)}$
Base to emitter saturation voltage	$\boldsymbol{V}_{\text{BE(sat)}}$	_	_	-1.2	V	$I_C = -1 A$ , $I_B = -0.1 A$ (Pulse test)
Gain bandwidth product	f <sub>T</sub>	_	150	_	MHz	$V_{CE} = -2 \text{ V},$ $I_{C} = -10 \text{ mA (Pulse test)}$
Collector output capacitance	Cob	_	35	_	pF	$V_{CB} = -10 \text{ V}, I_{E} = 0,$ f = 1 MHz

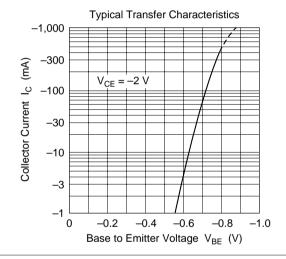
Note: 1. The 2SB1002 is grouped by  $h_{\text{FE}}$  as follows.

Mark	СН	CJ
h <sub>FE</sub>	100 to 200	160 to 320



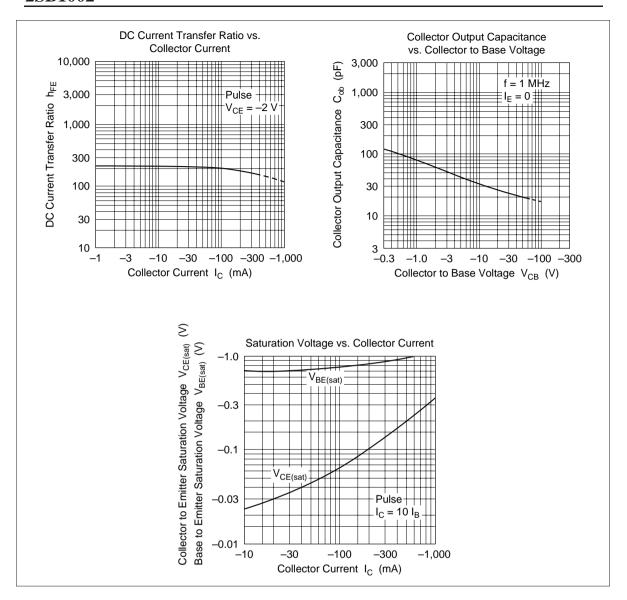




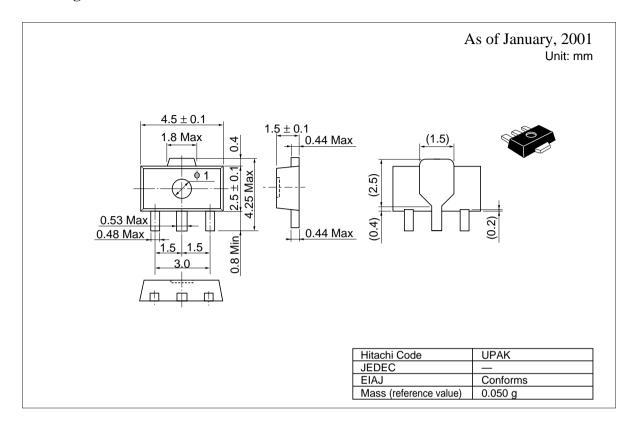


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# 2SB1002



## **Package Dimensions**



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Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

**URL** NorthAmerica http://semiconductor.hitachi.com/ http://www.hitachi-eu.com/hel/ecg Europe Asia http://sicapac.hitachi-asia.com Japan http://www.hitachi.co.jp/Sicd/indx.htm

For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Germany

Hitachi Europe GmbH Electronic Components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Fax: <1>(408) 433-0223 Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00

> Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead

Berkshire SL6 8YA, United Kingdom Tel: <886>-(2)-2718-3666 Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel: <65>-538-6533/538-8577 Fax: <65>-538-6933/538-3877 URL: http://www.hitachi.com.sg

Hitachi Asia Ltd. (Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building, Taipei (105), Taiwan

Fax: <886>-(2)-2718-8180 Telex: 23222 HAS-TP URL: http://www.hitachi.com.tw Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon, Hong Kong

Tel: <852>-(2)-735-9218 Fax: <852>-(2)-730-0281 URL: http://www.hitachi.com.hk

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